

NPN 100mA 50V Digital Transistors (Bias Resistor Built-in Transistors)

| Parameter      | Value |
|----------------|-------|
| $V_{\sf CEO}$  | 50V   |
| I <sub>C</sub> | 100mA |
| R              | 100kΩ |

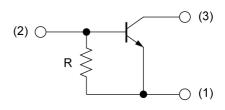
# Outline SOT-323 (2) (1) SOT-346 (2) (3) (4) (1) (1)

# ●Inner circuit

DTC115GU3 (UMT3)

#### Features

- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 4) Complementary PNP Types: DTA115G series
- 5) Lead Free/RoHS Compliant.



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

#### Application

Switching circuit, Inverter circuit, Interface circuit,

Driver circuit

#### Packaging specifications

| Part No.            | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width (mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
|---------------------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| DTC115GU3           | SOT-323<br>(UMT3) | 2021            | T106           | 180               | 8               | 3000                            | K29     |
| DTC115GKA<br>(NRND) | SOT-346<br>(SMT3) | 2928            | T146           | 180               | 8               | 3000                            | K29     |

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

| Parameter                    |                |                   | Values      | Unit   |
|------------------------------|----------------|-------------------|-------------|--------|
| Collector-base voltage       |                |                   | 50          | V      |
| Collector-emitter voltage    |                |                   | 50          | V      |
| Emitter-base voltage         |                |                   | 5           | V      |
| Collector current            |                |                   | 100         | mA     |
| Dayyar dissination           | DTC115GU3      | D *1              | 200         | ma\/\/ |
| Power dissipation DTC115GKA  |                | P <sub>D</sub> *1 | 200         | mW     |
| Junction temperature         | T <sub>j</sub> | 150               | °C          |        |
| Range of storage temperature |                |                   | -55 to +150 | °C     |

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

| Davanastan                           | Currente ed          | Conditions  | Values |      |      | 1.1:4 |  |
|--------------------------------------|----------------------|---|--------|------|------|-------|--|
| Parameter                            | Symbol               | Conditions  | Min.   | Тур. | Max. | Unit  |  |
| Collector-base breakdown voltage     | BV <sub>CBO</sub>    | I <sub>C</sub> = 50μA                                       | 50     | -    | -    | V     |  |
| Collector-emitter breakdown voltage  | BV <sub>CEO</sub>    | BV <sub>CEO</sub> I <sub>C</sub> = 1mA                      |        | -    | 1    | V     |  |
| Emitter-base breakdown voltage       | BV <sub>EBO</sub>    | I <sub>E</sub> = 720μA                                      | 5      | -    | 1    | V     |  |
| Collector cut-off current            | I <sub>CBO</sub>     | V <sub>CB</sub> = 50V                                       | -      | -    | 0.5  | μA    |  |
| Emitter cut-off current              | I <sub>EBO</sub>     | V <sub>EB</sub> = 4V  | 30     | -    | 58   | μA    |  |
| Collector-emitter saturation voltage | V <sub>CE(sat)</sub> | I <sub>C</sub> = 10mA, I <sub>B</sub> = 0.5mA               | -      | -    | 0.3  | V     |  |
| DC current gain                      | h <sub>FE</sub>      | $V_{CE} = 5V, I_{C} = 5mA$                                  | 82     | -    | 1    | -     |  |
| Emitter-base resistance              | R                    | -   | 70     | 100  | 130  | kΩ    |  |
| Transition frequency                 | f <sub>T</sub> *2    | V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA,<br>f = 100MHz | -      | 250  | -    | MHz   |  |

<sup>\*1</sup> Each terminal mounted on a reference footprint

### ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Grounded emitter propagation characteristics

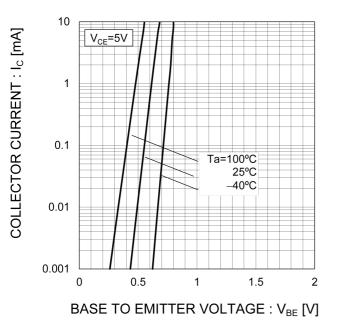


Fig.2 Grounded emitter output characteristics

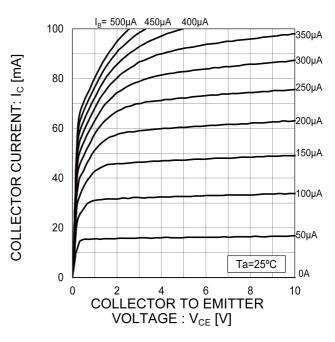


Fig.3 DC Current gain vs. Collector Current

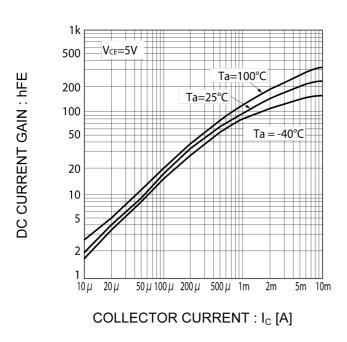
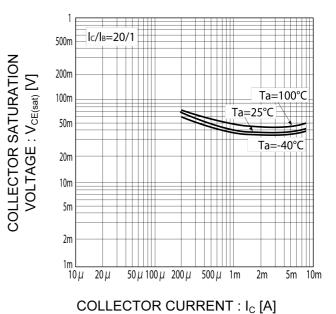


Fig.4 Collector-emitter saturation voltage vs. Collector Current



#### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

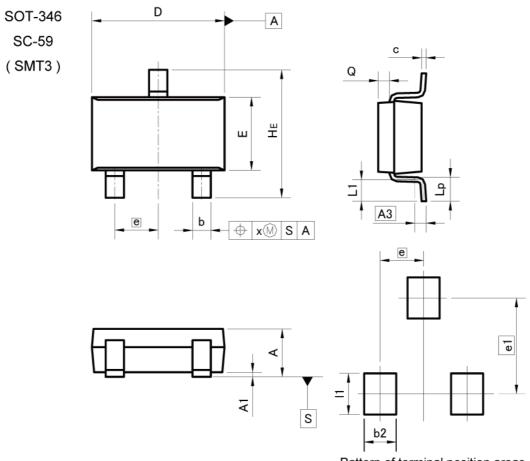
| DIM | MILIMETERS |      | INCHES |       |
|-----|------------|------|--------|-------|
| DIM | MIN        | MAX  | MIN    | MAX   |
| Α   | 0.80       | 1.00 | 0.031  | 0.039 |
| A1  | 0.00       | 0.10 | 0.000  | 0.004 |
| A3  | 0.5        | 25   | 0.0    | 10    |
| b   | 0.25       | 0.40 | 0.010  | 0.016 |
| С   | 0.10       | 0.20 | 0.004  | 0.008 |
| D   | 1.90       | 2.10 | 0.075  | 0.083 |
| E   | 1.15       | 1.35 | 0.045  | 0.053 |
| е   | 0.         | 65   | 0.026  |       |
| HE  | 2.00       | 2.20 | 0.079  | 0.087 |
| L1  | 0.10       | 0.40 | 0.004  | 0.016 |
| Lp  | 0.25       | 0.55 | 0.010  | 0.022 |
| Q   | 0.10       | 0.30 | 0.004  | 0.012 |
| х   | -          | 0.10 | -      | 0.004 |

| DIM  | MILIMETERS |      | INCHES |       |  |
|------|------------|------|--------|-------|--|
| DIM  | MIN        | MAX  | MIN    | MAX   |  |
| b2   | _          | 0.50 | _      | 0.020 |  |
| e1   | 1.55       |      | 0.0    | 61    |  |
| - 11 | -          | 0.65 | -      | 0.026 |  |

Dimension in mm/inches



#### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIMETERS |      | INCHES |       |
|-----|------------|------|--------|-------|
| DIM | MIN        | MAX  | MIN    | MAX   |
| Α   | 1.00       | 1.30 | 0.039  | 0.051 |
| A1  | 0.00       | 0.10 | 0.000  | 0.004 |
| A3  | 0.3        | 25   | 0.0    | 10    |
| b   | 0.35       | 0.50 | 0.014  | 0.020 |
| С   | 0.09       | 0.25 | 0.004  | 0.010 |
| D   | 2.80       | 3.00 | 0.110  | 0.118 |
| E   | 1.50       | 1.80 | 0.059  | 0.071 |
| е   | 0.9        | 95   | 0.037  |       |
| HE  | 2.60       | 3.00 | 0.102  | 0.118 |
| L1  | 0.30       | 0.60 | 0.012  | 0.024 |
| Lp  | 0.40       | 0.70 | 0.016  | 0.028 |
| Q   | 0.20       | 0.30 | 0.008  | 0.012 |
| х   | -          | 0.10 | -      | 0.004 |
| У   | - 2        | 0.10 | ·-     | 0.004 |

| 3 | DIM | MILIMETERS |      | INCHES |       |  |
|---|-----|------------|------|--------|-------|--|
|   | DIM | MIN        | MAX  | MIN    | MAX   |  |
|   | b2  | -          | 0.60 | _      | 0.024 |  |
|   | e1  | 2.10       |      | 0.0    | 83    |  |
|   | 11  | -3         | 0.90 | -      | 0.035 |  |

Dimension in mm/inches



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|---------|-----------|------------|-----------|
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| CLASSIV | CLASSII   | CLASSⅢ     | CLASSⅢ    |

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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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